

To the Honorable Cor	101877826	e attached original documents or copy the	ereof.	
1. Name of conveying p		Name and address of receiving party		
Lingyi A. Zhen	g	Name: Micron Technology, Inc.	2 =	
10/	x Q. / = 1	Street Address: 8000 S. Federal V	Way E	
10/0	09/01	City: Boise State: ID ZIP: 837	<u>/06-9632</u>	
Additional name(s) of conveyi	ing parties attached? □Yes ■ No		405 09/9	
3. Nature of conveyance	∂ :		<u>۲</u>	
■ Assignment □ Merg □ Security Agreement □ □ Other	Change of Name			
Execution Date: September 26, 2001		Additional name(s) & address(es) attached	Additional name(s) & address(es) attached? ☐ Yes ■ No	
4. Application number(s	s) or patent number(s):			
A. Patent Application ETAI 00000014 09973505 40.0 Name and address of	Additional numbers	Patent No. 97350 attached? □ Yes ■ No 6. Total number of applie	cations and	
pondence concerning mailed:		patents involved: One (1)		
Name: <u>Kristine N</u>	M. Strodthoff	7. Total fee	\$40.00	
Internal Address: Why	yte Hirschboeck Dudek S.C.	■ Enclosed		
Street Address: 111 E	ast Wisconsin Avenue	☐ Authorized to Deposit Acco	be charged to unt No. 23-2053	
Suite 2100				
City: Milwaukee State	e: <u>WI</u> ZIP: <u>53202</u>			
	DO NOT US	E THIS SPACE		
Statement and signate To the best of my kno true copy of the original	wledge and belief, the foregoin	g information is true and correct and any	attached copy is a	
Kristine M. Strodthoff	Kristine M	Stoodlugg Octob	per 9, 2001	
Name of Person Signing	Signature	Total number of pages including o	over sheet: Four (4)	

MKE/715899.1

PATENT REEL: 012247 FRAME: 0001 For: [X] U.S. and/or [X] Foreign-Rights
For: [X] U.S. Application-or [] U.S. Provisional Application
For: [X] U.S. Patent For: [] PCT Application
By: [X] Inventor or [] Present-Owner

ASSIGNMENT OF INVENTION (SINGLE INVENTOR)

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration,

ASSIGNOR:

Lingyi A. Zheng 2535 E. Red Cedar Lane, #202

Inventor(s) or person(s) or entity(ies) who own the invention Boise, ID 83716

Address

Nationality PRC

hereby sells, assigns and transfers to

ASSIGNEE:

Micron Technology, Inc. 8000 S. Federal Way

Inventor(s) or person(s) or entity(ies) who own the invention Boise, Idaho 83706-9632

Address

and the successors, assigns and legal representatives of the ASSIGNEE (complete one of the following)

- [X] the entire right, title and interest
- [] an undivided percent (%) interest for the United States and its territorial possessions
- [X] and in all foreign countries, including all rights to claim priority in and to any and all improvements which are disclosed in the invention entitled:

Method of Forming Inside Rough and Outside Smooth HSG Electrodes and Capacitor Structure

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PATENT REEL: 012247 FRAME: 0002

and which is	s found in	n (37 C.F.R. § 3.21)		
(a)	[X]	U.S. patent application executed on even date herewith		
(b)	[]	U.S. patent application executed on		
(c)	[]	U.S. provisional application naming the above inventor(s) for the above-entitled invention		
	[]	Express mail label no.:		
		Mailed:		
	[]	To comply with 37 C.F.R. § 3.21 for recordal of this assignment, I, an ASSIGNOR signing below, hereby authorize and request my attorney to insert below the filing date and application number when they become known.		
(d)	[]	U.S. application nofiled on		
(e)	[]	International application noPCT/ filed on		
(f)	[]	U.S. patent noissued		
	[]	A change of address to which correspondence is to be sent regarding patent maintenance fees is being sent separately.		
(check (g), if fo	oreign appl	ication(s) is also being assigned)		
(g)	[X]	and any legal equivalent thereof in a foreign country, including the right to claim priority		
and, in and to continuation re-examination	, divisior	ters Patent to be obtained for said invention by the above application or any n, renewal, or substitute thereof, and as to letters patent any reissue or of.		
ASS been or will	IGNOR l be made	nereby covenants that no assignment, sale, agreement or encumbrance has or entered into which would conflict with this assignment.		

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent

promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and

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deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

IN WITNESS	WHEREOF, I have hereunto set hand and seal this _	day of
, 2001.		

WARNING: The date of signing must be the same as the date of execution of the application, if item (a) was checked above.

Date: 09/26/2001

Lingyi A. Zheng

Subscribed and sworn to before me this <u>26</u> day of <u>Sept.</u>, 2001.

Notary Public, State of Idaho

My Commission Expires: 6/12/2004

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RECORDED: 10/09/2001

PATENT REEL: 012247 FRAME: 0004